



RoHS Compliant



MDES14N045RH

Single N-channel Trench MOSFET 135V, 180A, 4.5mΩ

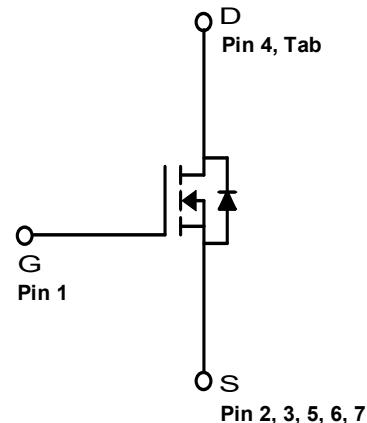
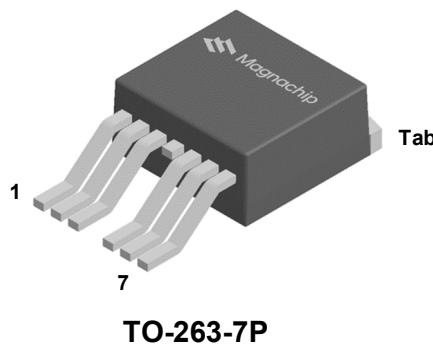
General Description

The MDES14N045RH, Magnachip's latest generation of MV MOSFET Technology, which provides high performance in the lowest R_{ds(on)}, fast switching performance, and excellent quality.

These devices can also be utilized in industrial applications such as Low Power Drives of E-bike, Light electric vehicles, DC/DC converter, and general purpose applications.

Features

- V_{DS} = 135V
- I_D = 180A @ V_{GS} = 10V
- Very low on-resistance R_{DS(ON)} < 4.5 mΩ @ V_{GS} = 10V
- 175 °C operating temperature
- 100% UIL Tested
- 100% R_g Tested
- 100% △V_{DS} Tested



Absolute Maximum Ratings (T_J = 25 °C)

| Characteristics | | Symbol | Rating | Unit |
|--|---|-----------------------------------|---------|------|
| Drain-Source Voltage | | V _{DSS} | 135 | V |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current ⁽¹⁾ | T _c =25°C (Silicon Limited) | I _D | 204 | A |
| | T _c =25°C (Package Limited) | | 180 | |
| | T _c =100°C (Silicon Limited) | | 144 | |
| Pulsed Drain Current ⁽²⁾ | | I _{DM} | 720 | |
| Power Dissipation | T _c =25°C | P _D | 375 | W |
| | T _c =100°C | | 187 | |
| Single Pulse Avalanche Energy ⁽³⁾ | | E _{AS} | 450 | mJ |
| Junction and Storage Temperature Range | | T _J , T _{stg} | -55~175 | °C |

Thermal Characteristics

| Characteristics | | Symbol | Rating | Unit |
|---|--|------------------|--------|------|
| Thermal Resistance, Junction-to-Ambient | | R _{θJA} | 40 | °C/W |
| Thermal Resistance, Junction-to-Case | | R _{θJC} | 0.4 | |

Ordering Information

| Part Number | Temp. Range | Package | Packing | RoHS Status |
|--------------|-------------|-----------|-------------|--------------|
| MDES14N045RH | -55~175°C | TO-263-7P | Tape & Reel | Halogen Free |

Electrical Characteristics ($T_J = 25^\circ\text{C}$)

| Characteristics | Symbol | Test Condition | Min | Typ | Max | Unit |
|--|-----------------------------|---|-----|-------|-----------|------------------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D = 250\mu\text{A}, V_{\text{GS}} = 0\text{V}$ | 135 | - | - | V |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 2.5 | - | 3.9 | |
| Drain Cut-Off Current | $I_{\text{DS}(\text{off})}$ | $V_{\text{DS}} = 135\text{V}, V_{\text{GS}} = 0\text{V}$ | - | - | 1.0 | μA |
| Gate Leakage Current | I_{GSS} | $V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$ | - | - | ± 0.1 | |
| Drain-Source ON Resistance | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 50\text{A}$ | - | 3.8 | 4.5 | $\text{m}\Omega$ |
| Forward Transconductance | g_{fs} | $V_{\text{DS}} = 10\text{V}, I_D = 50\text{A}$ | - | 122 | - | S |
| Dynamic Characteristics | | | | | | |
| Total Gate Charge | Q_g | $V_{\text{DS}} = 70\text{V}, I_D = 50\text{A}, V_{\text{GS}} = 10\text{V}$ | - | 123 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 41 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 22 | - | |
| Input Capacitance | C_{iss} | $V_{\text{DS}} = 70\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0\text{MHz}$ | - | 9,267 | - | pF |
| Reverse Transfer Capacitance | C_{rss} | | - | 27 | - | |
| Output Capacitance | C_{oss} | | - | 923 | - | |
| Turn-On Delay Time | $t_{\text{d}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 70\text{V}, I_D = 50\text{A}, R_G = 3.0\Omega$ | - | 36 | - | ns |
| Rise Time | t_r | | - | 21 | - | |
| Turn-Off Delay Time | $t_{\text{d}(\text{off})}$ | | - | 83 | - | |
| Fall Time | t_f | | - | 13 | - | |
| Gate Resistance | R_g | $f=1\text{ MHz}$ | - | 3 | - | Ω |
| Drain-Source Body Diode Characteristics | | | | | | |
| Source-Drain Diode Forward Voltage | V_{SD} | $I_S = 50\text{A}, V_{\text{GS}} = 0\text{V}$ | - | 0.9 | 1.2 | V |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 50\text{A}, dI/dt = 125\text{A}/\mu\text{s}$ | - | 117 | - | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 538 | - | nC |

Note :

1. Surface mounted FR-4 board by JEDEC (jesd51-7). Continuous current at $T_c=25^\circ\text{C}$ is silicon limited
2. Pulse width limited by $T_{J,\text{max}}$
3. E_{AS} is tested at starting $T_J = 25^\circ\text{C}$, $L = 1.0\text{mH}$, $I_{AS} = 30\text{A}$, $V_{\text{GS}} = 10\text{V}$.

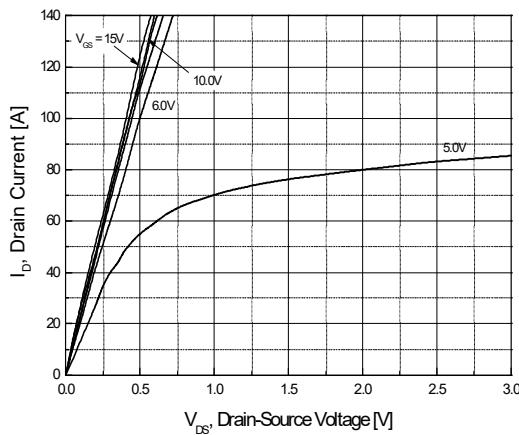


Fig.1 On-Region Characteristics

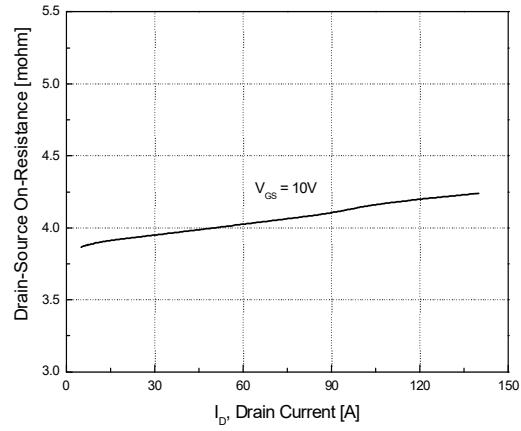


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

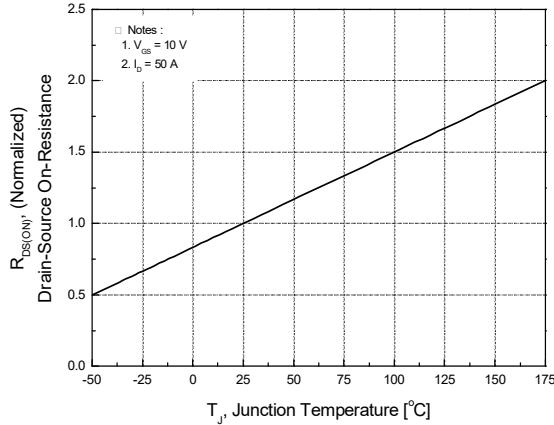


Fig.3 On-Resistance Variation with Temperature

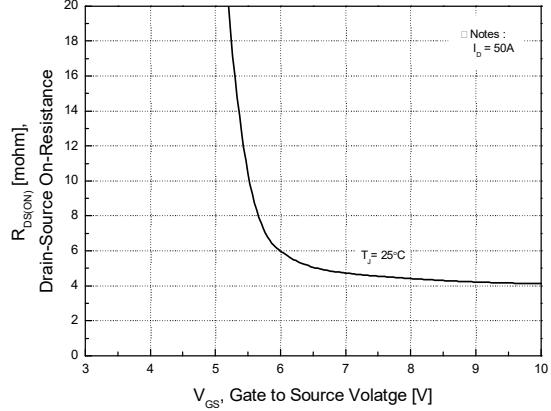


Fig.4 On-Resistance Variation with Gate to Source Voltage

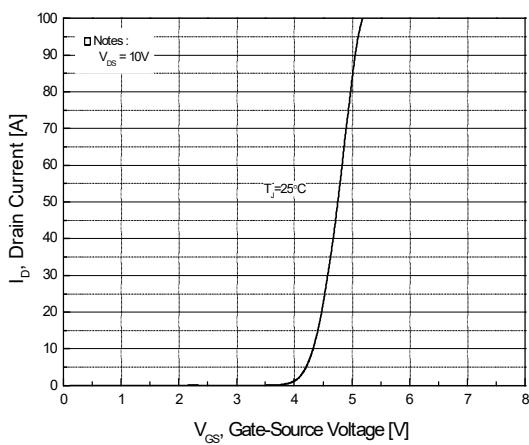


Fig.5 Transfer Characteristics

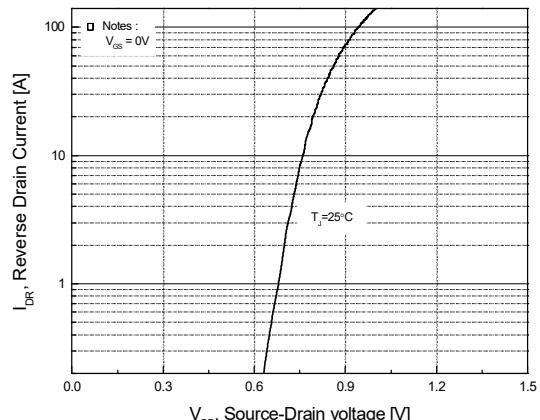


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

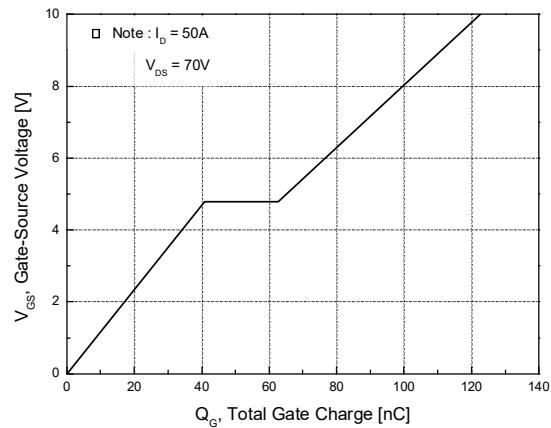


Fig.7 Gate Charge Characteristics

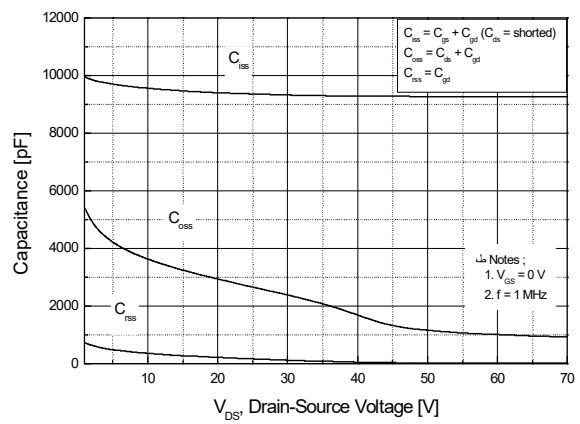


Fig.8 Capacitance Characteristics

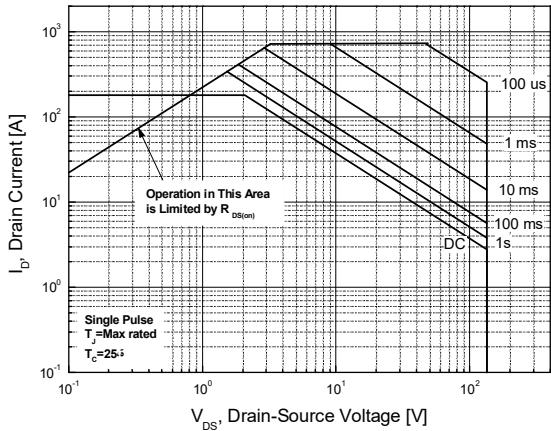


Fig.9 Maximum Safe Operating Area

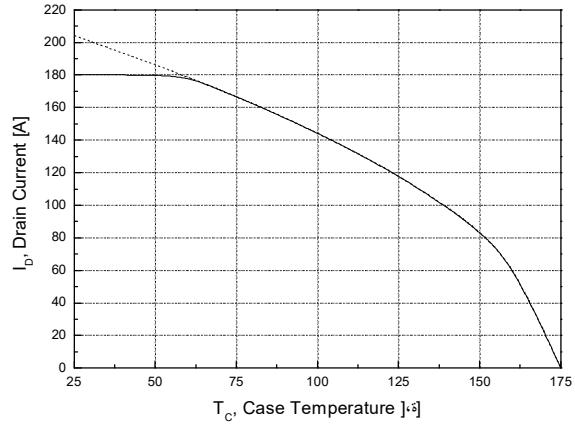


Fig. 10 Maximum Drain Current vs. Case Temperature

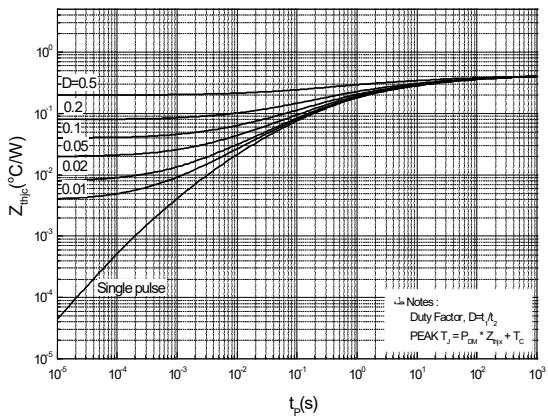
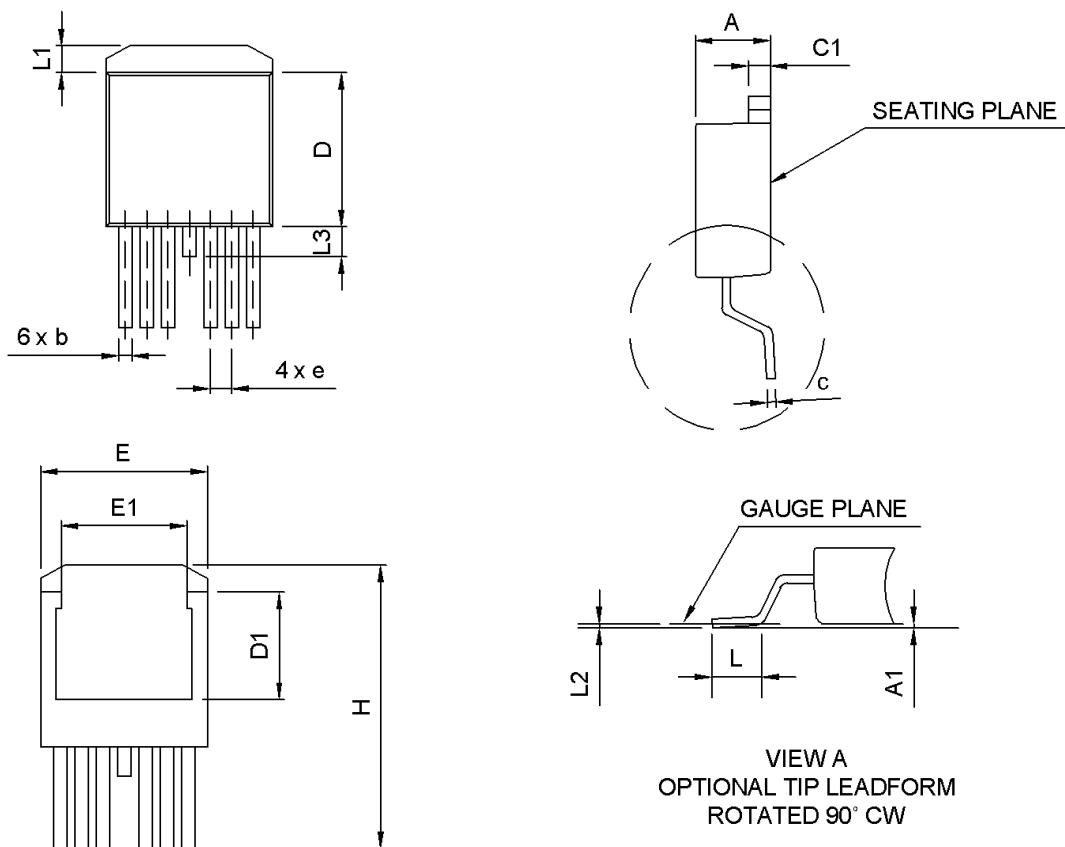


Fig.11 Transient Thermal Response Curve

Package Dimension

TO-263-7P

Dimensions are in millimeters unless otherwise specified



VIEW A
OPTIONAL TIP LEADFORM
ROTATED 90° CW

| Symbol | Dimension [mm] | |
|--------|----------------|-------|
| | Min | Max |
| A | 4.30 | 4.70 |
| A1 | - | 0.254 |
| b | 0.65 | 0.90 |
| c | 0.40 | 0.60 |
| c1 | 1.25 | 1.40 |
| D | 9.00 | 9.40 |
| D1 | 5.90 | 6.90 |
| E | 9.68 | 10.20 |
| E1 | 7.70 | 8.50 |
| e | 1.27BSC | |
| H | 14.61 | 15.88 |
| L | 1.78 | 2.80 |
| L1 | - | 1.6 |
| L2 | 0.254BSC | |
| L3 | - | 1.78 |

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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